

Vacuum dry oven

ETSP-VD series

ETSP-VD series are designed for removing water from the surface or interior of certain products or substrates or removal of moisture from water-based coatings and adhesives. MTS-VD series are designed and built to your specific requirements for part size, production rate and thermal characteristics.

ETSP-VD series are manufactured according to the Total Quality procedures, in compliance with the ISO 9001 standard.

ETSP-VD series



General Features

- Tight seal at a vacuum level by equipped door gasket and a push button latch
- Block type heaters heat the chamber evenly and good transmission by anodized aluminum plate shelve
- Heat tempered full view window permits continuous monitoring
- Programmable type temperature controller and programmable type vacuum controller (option)
- Excellent space efficiency and user friendly all in one type operating panel.
- Microprocess PID control / Auto-tuning /Calibration
- Over temperature limiter / Door opening alarm
- Digital LED display (1°C resolution) with touch-sensitive keypads
- RS-232/RS485 data interface

Technical Features

Temperature range	1	Ambient +5 °C ~ +250 °C
Temperature fluctuation	i	Less than ±0.5°C (vacuum), Less than ±1.0°C (atmospheric)
Temperature uniformity	1	Less than ± 2.0 ℃ at 100 ℃
Heat up time to 200 ℃	Î	Within 55 minutes under vacuum with no load
Max. final vacuum	1	100Pa (1mbar) (more higher vacuum range is option)
Pull down rate from atmos	ph	eric pressure to 1mbar Within 18minutes
Recovery time	1	Within 11 minutes
Input Power Requirements	1	220V / 380V , 50Hz/60Hz, 1PH/3PH (Changeable according to customer specification)

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